

DESCRIPTION

HSY8120B1ABC is awide input range, high-efficiency and high frequency DC-to-DC step-down switching regulator, capable of delivering up to 2A of output current. With a fixed switching frequency of 500KHz, this current mode PWM controlled converter allowsthe use ofsmall external components, such as ceramic input and output caps, as well as small inductors. HSY8120B1ABC also employs a proprietary control scheme that switches the device into a power save mode during light load, thereby extending the range of high efficiency op eration. An OVP function protects the IC itself and its downstream system against input voltage surges. With this OVP function, the IC can stand off input voltage as high as 19V, making it an ideal solution for industrial applicationssuch as LCDTV, Set Top Box, Portable TV, etc.

HSY8120B1ABC is available in SOT-23-6L package.

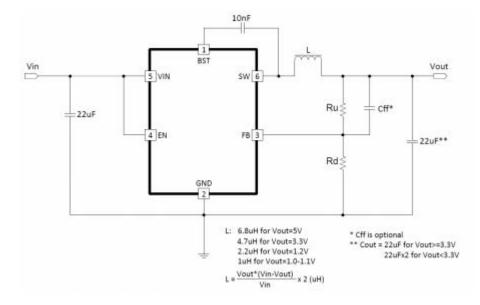
FEATURES

- Wide Input Range: 4.2V-18V
- High Efficiency PFM mode at light load
- Capable of Delivering 2A
- No External Compensation Needed
- Current Mode Control
- Thermal Shutdown and UVLO
- Excellent Load and Line Transient Response Available in SOT23-6 Package

APPLICATIONS

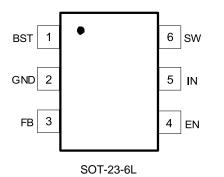
- LCD TV
- Set Top Box
- Portable TV

TYPICAL APPLICATION





PIN CONFIGURATION



ABSOLUTEMAXIMUM RATINGS

(Note: Exceeding these limits maydamage the device. Exposure to absolute maximum rating conditions for long periods mayaffect device reliability.)

IN,SW,ENVoltage		0.3	V to 19V
BST Voltage		0.3V to	SW+6V
FB Voltage		0.	3V to 6V
Operating Temperature Rang	ge	40°C	C to 85°C
Storage Temperature Range		55°C	to 150°C
Thermal Resistance	θја	θлс	
SOT-23-6L	180	90	°C/W
Lead Temperature (Soldering	g 10ssec	;)	260°C
ESD HBM (Human Body Mod	de)		2KV
ESD MM (Machine Mode)			200V

PIN DESCRIPTION

PIN #	NAME	DESCRIPTION
1	BST	Bootstrap pin. Connect a 10nF capacitor from this pin to SW
2	GND	Ground
3	FB	Feedback Input. Connect an external resistor divider from the output to FB and GND to set V_{OUT}
4	EN	Enable pin for the IC. Drive this pin high to enable the part, low to disable.
5	VIN	Supply Voltage. Bypass with a 4.7µFceramic capacitor to GND
6	SW	Inductor Connection. Connect an inductor Between SW and the regulator output.



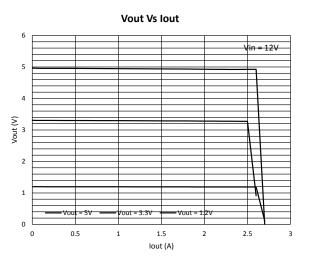
ELECTRICAL CHACRACTERISTICS

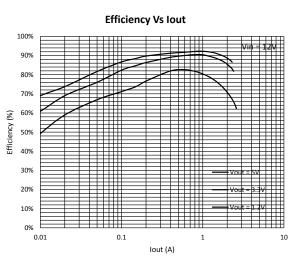
(V_IN= 12V, V_OUT= 3.3V, unless otherwise specified. Typical values are at TA = 25°C.)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
Input Voltage Range		4.2		18	V
Input UVLO	Rising, Hysteresis=340mV		4.2		V
Input OVP	Rising, Hysteresis=1V		19		V
Input Supply Current	VF <u>B</u> =0.65V		700		μA
Input ShutdownCurrent			7	14	μA
FB Voltage		0.588	0.6	0.612	V
FB Input Current			0	1	μA
Switching Frequency			500		kHz
Maximum Duty Cycle			99		%
Short Circuit Hiccup Time	On Time		2		mS
	Off Time		6		mS
FB Hiccup Threshold			0.2		V
High Side Switch On Resistance			160		mΩ
Low Side Switch On Resistance			95		mΩ
High Side Current Limit			3.5		А
SW Leakage Current	IN=SW=12V			20	μA
ENRising Threshold			1.5		V
EN FallingThreshold			1.3		V
EN Input Current	VEN=2V		1		uA
Thermal Shutdown	Rising, Hysteresis =40°C		150		C

TYPICAL CHARACTERISTICS

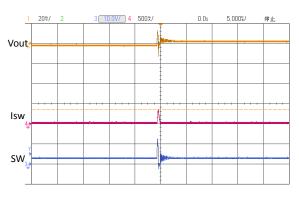
(Typical values are at $T_{\text{A}}\text{=}25^{\circ}\text{C}$ unless otherwise specified.)



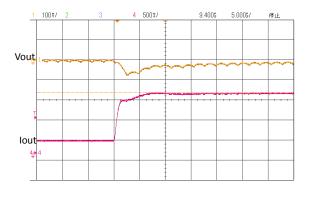




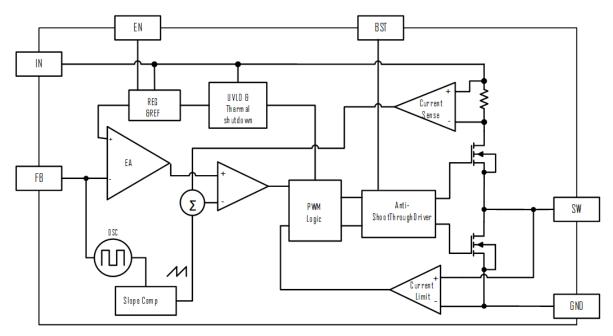
Switching Waveform at lout = 0A (Vin=12V, Vout=3.3V)



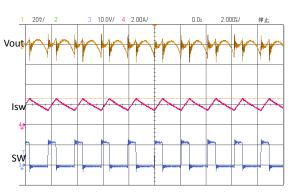
Load Transient Response –Iout Rising Edge 1A/1us Vin=12V, Vout=1.1V, L=2.2uH, Cout=22uFx2, Iout 0.3-1.5A



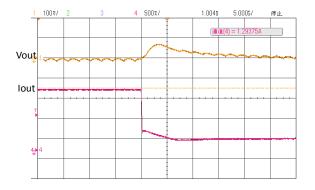
FUNCTIONAL BLOCK DIAGRAM



Switching Waveform at lout = 2A (Vin=12V, Vout=3.3V)



Load Transient Response – Iout Falling Edge 1A/0.2us Vin=12V, Vout=1.1V, L=2.2uH, Cout=22uFx2, Iout 1.5-0.3A





FUNCTIONAL DESCRIPTION

The HSY8120B1ABC is a synchronous buck regulator ICs that integrates the PWM control, top and bottom switches on the same die to minimize the switching transition loss and conduction I

The HSY8120B1ABC is a wide input range, high efficiency, DC-to-DC step-down switching regulator, capable of delivering up to 2A of output current, integrated with a $160m\Omega$ high side and $95m\Omega$ low side MOSFET. It uses PWM current-mode control scheme. An error amplifier integrates error between the FB signal and the internal reference voltage. The output of the integrator is then compared to the sum of a current-sense signal and the slope compensation ramp. This operation generates a PWM signal that modulates the duty cycle of the power MOSFET to achieve regulation for output voltage.

Light Load Operation

Traditionally, a fixed constant frequency PWM DC-DC regulator always switches even when theoutput load is small. When energy is shuffling back and forth through the power MOSFET, power is lost due to the finite Rdson of the MOSFET and parasitic capacitances. At light load, this loss is prominent and efficiency is therefore very low. HSY8120B1ABC employs a proprietary control scheme that improves efficiency inthis situation by enabling thendevice into a power save mode during light load, thereby extending the range of high efficiency operation.

Enable

EN is a digital control pin that turns the HSY8120B1ABC on and off. Drive EN High to turn on the regulator, drive it Low to turnit off. An internal $1M\Omega$ resistor from EN pin to GND allows EN to float to shutdown the chip. Connecting the EN pin through a pull up resistor or shorted EN to IN will automatically turn on the chip whenever plug in IN.

Over Current Protection and Hiccup

HSY8120B1ABC has a cycle-by-cycle over current limit for when the inductor current peak value is over the set current limit threshold. When the output voltage drop until FB falls below UVthreshold (0.2V), the HSY8120B1ABC will enter hiccup mode. It will turn off the chip immediately for 6mS. After that, it will try to re-starts as normal for 2mS. After 2mS, if FB is still below UV threshold, then the chip enters hiccup mode again. If FB is higher than UV threshold, it will enter the normal mode.

Over-Temperature Protection

Thermal protection disables the output when the junction temperature rises to approximately 150°C, allowing the device to cooldown. When the junction temperature cools to approximately 110°C, the output circuitry is again abled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit may cycle on and off. This cycling limits regulator dissipation, protecting the device from damage as aresult of overheating.



APPLICATION INFORMATION

External Output Voltage Setting

In external Output Voltage Setting Version selected, the HSY8120B1ABC regulator is programmed using an external resistor divider. The output voltage is calculated using below equation.

$$V_{OUT} = V_{REF} \times (1 + \frac{R_u}{R_d})$$

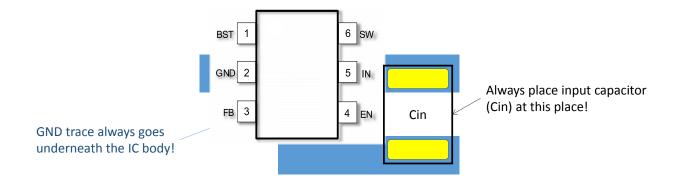
Where:VREF =0.6V typically(theinternal reference voltage)

Resistors Rdhas to be between 1kOhm to 20KOhmand thus Ru is calculated by following equation.

$$R_u = \left(\frac{V_{OUT}}{V_{REF}} - 1\right) \times R_d$$

PCB LAYOUT GUIDE

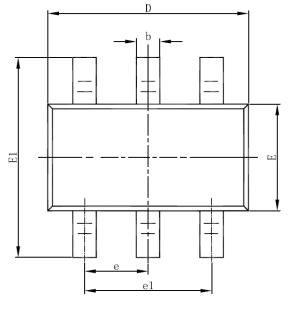
For any high voltage buck, it is always crucial to have input capacitor placed as close to the chip's IN and GND pin without any via, because the input capacitor is to keep the chip's real input voltage from droppi ng too much when large switching current is drawn from the input node. A simple illustration of how to pla ce input capacitor and draw the trace to the chip's IN and GND pins isshown below, and it is highly recommended to strictly follow this guide.

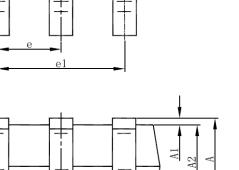


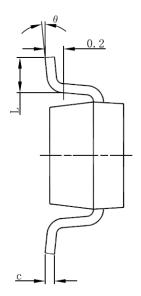


PACKAGE OUTLINE

Package: SOT-23-6L







Sumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
A	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	0.950	(BSC)	0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	



Attention

Any and all HUA XUAN YANG ELECTRONICS products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your HUA XUAN YANG ELECTRONICS representative nearest you before using any HUA XUAN YANG ELECTRONICS products described or contained herein in such applications.

• HUA XUAN YANG ELECTRONICS assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein.

• Specifications of any and all HUA XUAN YANG ELECTRONICS products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.

HUA XUAN YANG ELECTRONICS CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could

give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

• In the event that any or all HUA XUAN YANG ELECTRONICS products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

• No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of HUA XUAN YANG ELECTRONICS CO.,LTD.

Information (including circuit diagrams and circuit parameters) herein is for example only ; it is not guaranteed for volume production.
HUA XUAN YANG ELECTRONICS believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.

Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the HUA XUAN YANG ELECTRONICS product that you intend to use.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Switching Controllers category:

Click to view products by HXY MOS manufacturer:

Other Similar products are found below :

NCP1218AD65R2G NCP1244BD065R2G NCP6153MNTWG NCP81101BMNTXG NCP81205MNTXG SJE6600 SG3845DM NCP4204MNTXG NCP6132AMNR2G NCP81102MNTXG NCP81206MNTXG MAX1653ESET NCP1240FD065R2G NCP1361BABAYSNT1G NCP1230P100G NX2124CSTR NCP1366BABAYDR2G NCP81174NMNTXG NCP4308DMTTWG NCP4308AMTTWG NCP1366AABAYDR2G NCP1251FSN65T1G NCP1246BLD065R2G NTE7233 ISL69122IRAZ MB39A136PFT-G-BND-ERE1 NCP1256BSN100T1G LV5768V-A-TLM-E NCP1365BABCYDR2G NCP1365AABCYDR2G NCP1246ALD065R2G AZ494AP-E1 CR1510-10 NCP4205MNTXG XC9221C093MR-G XRP6141ELTR-F RY8017 LP6260SQVF LP6298QVF ISL6121LIB ISL6225CA ISL6244HRZ ISL6268CAZ ISL6315IRZ ISL6420AIAZ-TK ISL6420AIRZ ISL6420IAZ ISL6421ERZ ISL6440IA ISL6441IRZ-TK